

**A T 2 4 C 2 5 6 C - S S H L - B**

**Product Family**  
24C = Standard I<sup>2</sup>C-compatible  
Serial EEPROM

**Device Density**  
256 = 256 Kilobit

**Device Revision**

**Shipping Carrier Option**

- B = Bulk (Tubes)
- T = Tape and Reel, Standard Quantity Option
- E = Tape and Reel, Extended Quantity Option

**Operating Voltage**

- L = 1.7V to 5.5V

**Device Grade or  
Wafer/Die Thickness**

- H or U = Industrial Temperature Range  
(-40°C to +85°C)
- 11 = 11mil Wafer Thickness

**Package Option**

- SS = SOIC
- X = TSSOP
- MA = 2.0mm x 3.0mm UDFN
- C = VFBGA
- WWU = Wafer Unsawn

**Note:** Refer to automotive data sheet for automotive grade ordering information.

Note 1: Refer to automatic data sheet for automatic grade ordering information.